

Corrected Application Data Sheet



Inventor Information

Inventor One Given Name:: Toshiyuki
Family Name:: SHIMIZU
Mailing Address Line One:: c/o Toyo Boseki Kabushiki Kaisha
Mailing Address Line Two:: Research Center
Mailing Address Line Three:: 1-1, Katata 2-chome
City:: Ohtsu-shi
State or Province:: Shiga
Country:: Japan
Citizenship Country:: Japan

Inventor Two Given Name:: Yuji
Family Name:: TADA
Mailing Address Line One:: c/o Otsuka Chemical Co., Ltd.
Mailing Address Line Two:: Tokushima Research Laboratories
Mailing Address Line Three:: 463, Kagasuno, Kawauchi-cho
City:: Tokushima-shi
State or Province:: Tokushima
Country:: Japan
Citizenship Country:: Japan

Correspondence Information

Customer Number:: 000023460
Electronic Mail One:: jkilyk@leydig.com
Electronic Mail Two:: rmadsen@leydig.com

Application Information

Title Line One:: HEAT-RESISTANT COMPOSITION
Total Drawing Sheets:: 0
Formal Drawings:: No
Docket Number:: 215697
Application Type:: Utility
Secrecy Order in Parent Appl.?:: No

Representative Information

Representative Customer Number :: 23460

Prior Foreign Applications

Foreign Application:: 2001-34161
Filing Date:: February 9, 2001
Country:: Japan
Priority Claimed:: Yes

Assignee Information

Name of Assignee One: Toyo Boseki Kabushiki Kaisha
Address Line One:: 2-8, Dojimahama 2-chome, Kita-ku
City:: Osaka-shi
State or Province:: Osaka
Country:: Japan

Name of Assignee Two: Otsuka Chemical Co., Ltd.
Address Line One:: 3-2-27, Ote-dori, Chuo-ku
City:: Osaka-shi
State or Province:: Osaka
Country:: Japan